File E28476 Project 08CA39621

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REPORT

on

COMPONENT - Connectors for Use in Data, Signal, Control and Power Applications - Component

TYCO ELECTRONICS CORP Harrisburg, PA

Recognized Company: TYCO ELECTRONICS CORP

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DESCRIPTION

PRODUCT COVERED:

USR, Component - Series SEC II Power Connector

USR, Component - Series MBCE Power Connector

USR, Component - Series SCE Power Connector

USR, Component - Series HD+ Card Edge Power Connector, 5 Beam

USR, CNR Component - Series HD+ Card Edge Power Connector, 8 Beam

USR, Component - Series 2 in 1 Card Edge Power Connector

USR, CNR Component - Series SBCE power connector

USR, CNR - Series Heighten-CE Power Connector

USR, CNR - Series LPCE Power Connector

GENERAL:

These devices are multi-pole, right angle, vertical and co-planar edge-card connectors intended for factory assembly on printed wiring boards where the acceptability of combinations is determined by Underwriters Laboratories Inc. The devices are identified as follows:

*USR indicates investigation to United States Standards, UL 1977.

CNR indicates investigation to Canadian National Standards, ${\tt C22.2~No.~182.3.}$

RATINGS: 40 A, 250 V for Series SEC II Power Connector

25 A, 250 V for Series MBCE Power Connector

24 A, 250 V for Series SCE Power Connector

Series No.	Contact	USR Rating Voltage, V	USR Rating Current, A	CNR Rating Voltage, V	CNR Rating Current, A
HD+ Card	Power	250	36	-	_
Edge Power Connector, 5 Beam	Signal	Not assign	Not assign	-	-
*HD+ Card	Power	250	61.2	250	51.5
Edge Power Connector, 8 Beam	Signal	60	3	60	4
2 in 1 Card	Power	250	250	-	_
Edge Power Connector	Signal	100	1	_	_
SBCE power Connector	Power	100	9.3	100	9.3

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Series No.	Contact	USR Rating	USR Rating	CNR Rating	CNR Rating
Series No.	Contact	Voltage, V	Current, A	Voltage, V	Current, A
Heighten-CE	Power	100	35	100	35
Power	Signal	_	_	_	_
Connector	Signai		_	_	
LPCE Power	Power	100	10.5	100	10.5
Connector	Signal	28	1.2	28	1.2

Flammability - V-2 for Series SEC II Power Connector
Disconnecting Use - see Sec Gen for required marking

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TECHNICAL CONSIDERATIONS (NOT FOR FIELD REPRESENTATIVE'S USE):

Use - For use only in or with complete equipment where the acceptability of the combination is determined by Underwriters Laboratories Inc.

Conditions of Acceptability - The following are among the considerations to be made when evaluating the device in the end-use product.

Interruption of Current

1. These devices are not suitable for interrupting the flow of current by connecting or disconnecting the mating connector.

Current-Carrying Capability and Current Ratings

2. These devices have been subjected to the (USR) Temperature Test with the rated currents and maximum temperature values tabulated below.

Series	Current, A	Maximum Temperature, °C
SEC II Power	40	58.1 #
MBCE Power Connector	25	84.2 #2
SCE Power Connector	24	49.1 #3

series	Contact	USR Current,	Maximum Temperature °C	Cat. No. tested to Represent
HD+ Card Edge	Power	36	75.9	2345246
Power Connector, 5 Beam	Signal	Not assign	_	
HD+ Card Edge	Power	61.2	82.7	2343428
Power Connector, 8 Beam #4	Signal	3	61.9	3 3 3 3 3 3
2 in 1 Card Edge	Power	250	66.0	2341077
Power Connector	Signal	1	46.4	

2A. These devices have been subjected to the (CNR) Temperature test with the rated currents and maximum temperature rise and recorded temperature (adjusted to $25\,^{\circ}$ C ambient) values tabulated below:

series	Contact	CNR Current,	Maximum Temperature Rise °C	Cat. No. tested to Represent
*HD+ Card Edge	Power	51.5	29.7	2343428
Power Connector, 8 Beam #5	Signal	4	22.4	

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2B. These devices have been subjected to the (USR and CNR) Temperature test with the rated currents and maximum temperature rise and recorded temperature (adjusted to $25\,^{\circ}$ C ambient) values tabulated below:

series	Contact	USR and CNR Current, A	Maximum Temperature Rise °C	Cat. No. tested to Represent
SBCE power connector #6	Power	9.3	23.2	2358256
Heighten-CE Power Connector #7	Power	35	24.3	2363332
LPCE Power	Power	10.5	5.2	2375562
Connector #8	Signal	1.2	4.9	(TYCO RM 704129)

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Note: # - With mating printed wiring board laminate 1.3 mm thick, copper alloy pads 0.24 mm thick and a min. of 5 mm wide.

- #2 With mating printed wiring board laminate 1.57 mm thick, 4 layers, 2 ounce copper on out layers and 1 ounce copper on internal layers.
- #3 With mating printed wiring board laminated 1.57 mm thick, 6 layers, 2-ounce copper on each layer.

#4

Terminal Side - With mating printed wiring board laminate 2.36 mm thick, 6 layers, 2 ounce copper on each layer.

Mating Side - With mating printed wiring board laminate 1.57 mm thick, 6 layers, 2 ounce copper on each layer.

#5

Terminal Side - With mating printed wiring board laminate 2.36 mm thick, 6 layers, 6 ounce copper on each layer.

Mating Side - With mating printed wiring board laminate 1.57 mm thick, 6 layers, 5 ounce copper on each layer.

#6

Terminal Side - With mating printed wiring board laminate 1.57 mm thick, 6 layers, 2 ounce copper on each layer.

Mating Side - With mating printed wiring board laminate 1.57 mm thick, 6 layers, 2 ounce copper on each layer.

#7 - With mating printed wiring board laminated 2.00 mm thick, 6 layers, 2-ounce copper on each layer.

A

Terminal Side - With mating printed wiring board laminate 1.57 mm thick, 6 layers, 2 ounce copper on each layer.

Mating Side - With mating printed wiring board laminate 1.57 mm thick, 6 layers, 2 ounce copper on each layer.

Voltage

3. These devices (except for SBCE power Connector, **Heighten-CE Power Connector, LPCE Power connector**) have been evaluated at a potential of 250 V based on

the result of a Dielectric Withstand Test performed at 1500 Vac.

Miscellaneous

- 4. The enclosure of the device has live parts that may be exposed to user contact when the connector is energized. The device is suitable for use only within an acceptable enclosure.
- 5. The suitability of the mounting means shall be determined in the enduse product.

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Insulating Materials

- 4. The insulating materials used in these devices comply with the direct support requirements of UL 746C, the Standard for Polymeric Materials Use in Electrical Equipment Evaluations.
- 5. The flame class rating of the insulating materials used in the connector housing is V-2 for series SEC II Connector.
- 6. These devices employ insulating materials with properties as tabulated below at the minimum thickness employed in the connector housing, the suitability of the insulating materials based on the documented values shall be determined in the end-use application. Please note the values specified in the table when multiple materials are indicated represent the minimum values for the group of materials.

α '	T 7 1 '	1 1		*****	T	D.M.T		
Series	Insulating		Flame	HWI	HAI	RTI	RTI	Max
	Material	Minimum	Class			Elec	Str	Operating
	(#)	Thickness						Temp, ⁰ C
SEC II	А	0.94 mm	V-2	0	1	150	150	150
MBCE,	B for	0.45 mm	V-0	4	3	105	65	105
right	housing, C							
angle	for							
	organizer							
MBCE,	В	0.45 mm	V-0	0	1	105	65	105
co-								
planar								
MBCE,	С	0.45 mm	V-0	4	3	130	130	130
vertical	Ü	0.10 11411	• 0	1	J	100		100
SCE	D	0.2 mm	V-0	_	_	130	130	130
Power	D	0.2 111111	٧ ٥			130	150	150
Connecto								
r			0	_		100	100	100
HD+ Card	D	0.3 mm	v −0	4	0	130	130	130
Edge								
Power								
Connecto								
r, 5								
Beam								
HD+ Card	D	0.3 mm	V-0	4	0	130	130	130
Edge								
Power								
Connecto								
r, 8								
Beam								
2 in 1	D	0.40 mm	V-0	4	0	130	130	130
Card								
Edge								
Power								
Connecto								
r								
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Series	Insulating	Measured	Flame	HWI	HAI	RTI	RTI	Max
	Material	Minimum	Class			Elec	Str	Operating
	(#)	Thicknes						Temp, °C
	(" /	s						10
~~~	_		0	4	4	100	100	100
SBCE	E	0.30 mm	V-0	4	4	130	130	130
power								
Connect								
Heighte	E	0.20mm	V-0	4	4	130	130	130
	10	0.20111111	V-0	7	7	150	130	150
n-CE								
Power								
Connect								
or								
LPCE	D or E	0.20mm	V-0	4	4	130	130	130
power								
Connect								
or								

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- (#) Code for Insulating Body Material.
- A. Tyco RM 704584.
  1. Dielectric strength (kV/mm): 26
  2. CTI: 1
- B. Tyco RM 704556.
  1. Dielectric strength (kV/mm): 23
  2. CTI: 1
- C. Tyco RM 1573551.
  1. Dielectric strength (kV/mm): 2. CTI: 2
- D. Tyco RM 1573878
  1. Dielectric strength (kV/mm):39
  2. CTI: 4
- E. Tyco RM 704129
  1. Dielectric strength (kV/mm):39
  2. CTI: 4